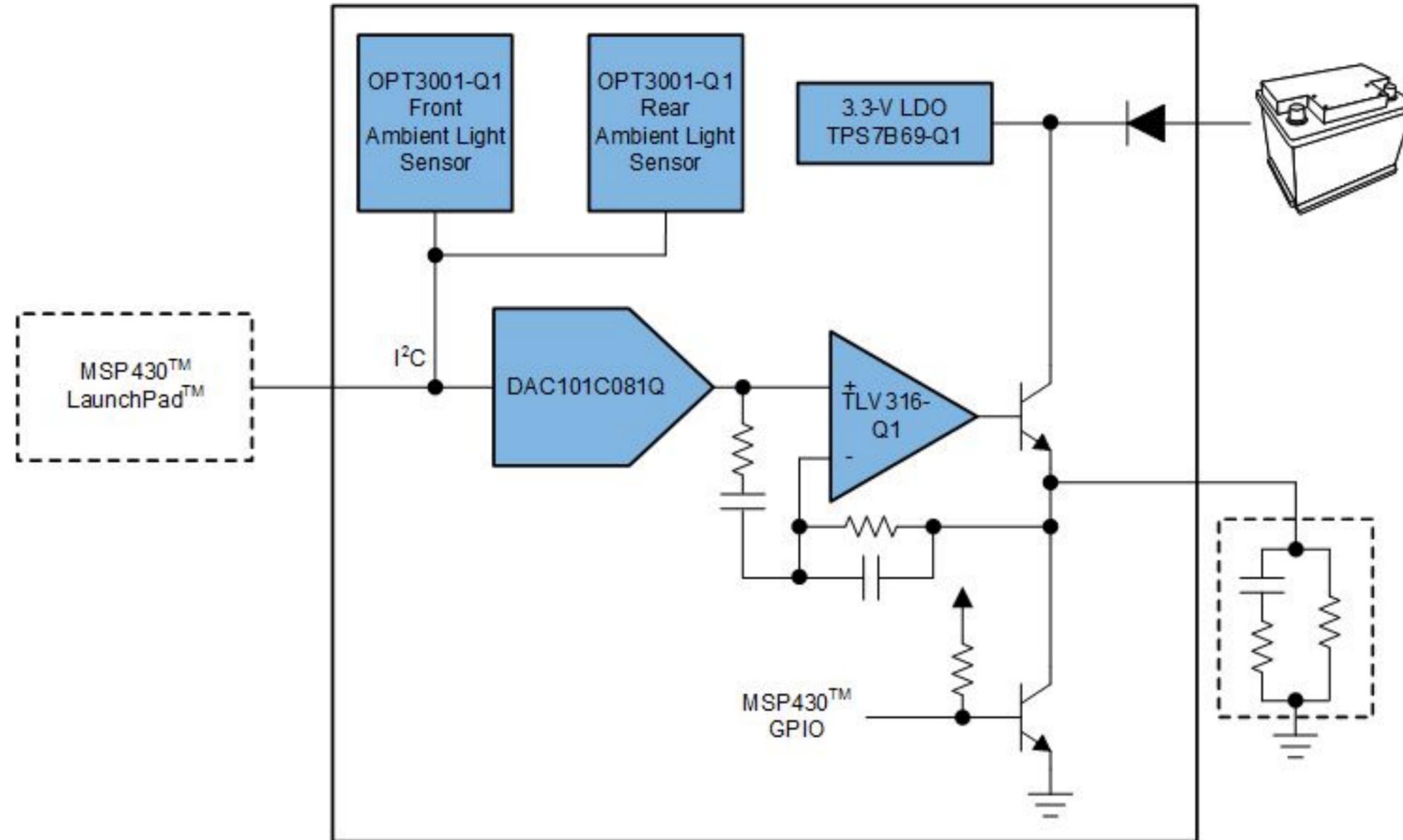


Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

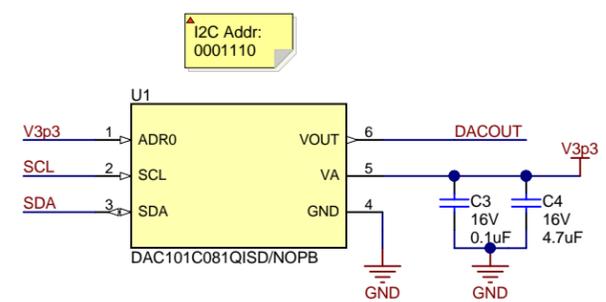


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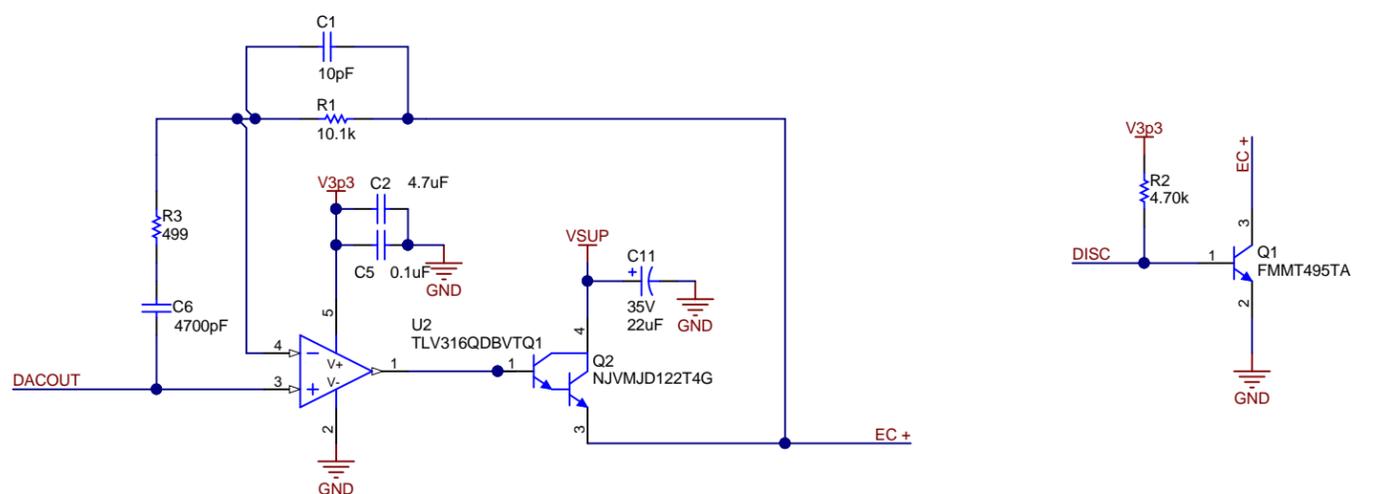
Orderable: TIDA-01539	Designed for: Public Release	Mod. Date: 4/26/2018
TID #: 01539	Project Title: EC Mirror Driver	
Number: TIDA-01539	Rev: E2	Sheet: 1 of 3
SVN Rev: Version control disabled	Assembly Variant: 001	File: TIDA-01539 EC Mirror Driver_CoverSheet.SchDoc
Drawn By:	Engineer: Matt Sullivan	Contact: http://www.ti.com/support



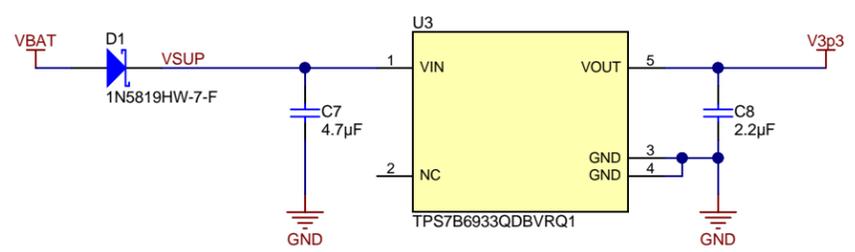
DAC



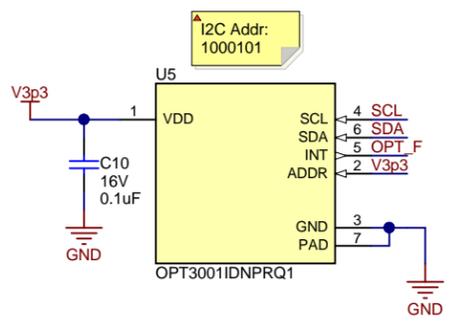
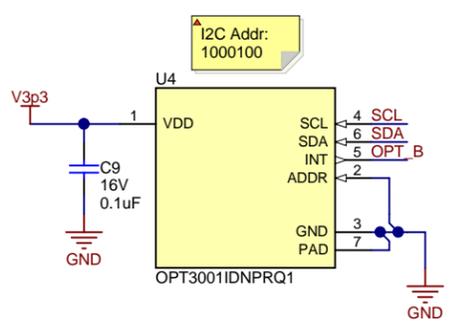
EC MIRROR DRIVER



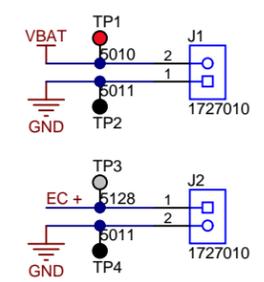
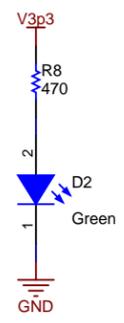
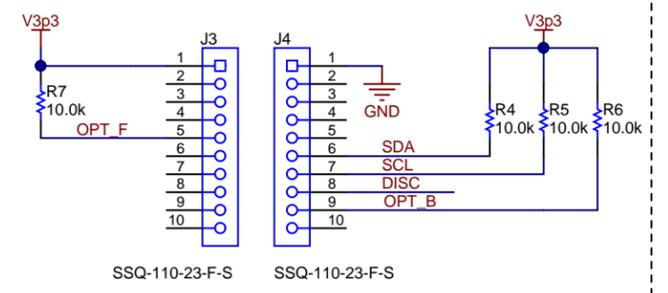
LDO



OPTICAL SENSORS



MISC



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DNP
FID1

DNP
FID2

DNP
FID3

PCB Number: TIDA-01539
PCB Rev: E2

PCB
LOGO

PCB
LOGO

Variant/Label Table	
Variant	Label Text
001	TIDA-01539

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ3
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ4
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

Orderable: TIDA-01539	Designed for: Public Release	Mod. Date: 4/26/2018	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2017
TID #: 01539	Project Title: EC Mirror Driver		
Number: TIDA-01539	Rev: E2	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: Matt Sullivan	File: TIDA-01539 EC Mirror Driver EVM Hardware Schematic	Contact: http://www.ti.com/support	

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